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## FDPC8014S PowerTrench<sup>®</sup> Power Clip 25V Asymmetric Dual N-Channel MOSFET

### Features

Q1: N-Channel

- Max  $r_{DS(on)}$  = 3.8 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 20 A
- Max  $r_{DS(on)}$  = 4.7 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 18 A

Q2: N-Channel

- Max  $r_{DS(on)}$  = 1.2 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 41 A
- Max  $r_{DS(on)}$  = 1.4 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 37 A
- Low inductance packaging shortens rise/fall times, resulting in lower switching losses
- MOSFET integration enables optimum layout for lower circuit inductance and reduced switch node ringing

PIN1

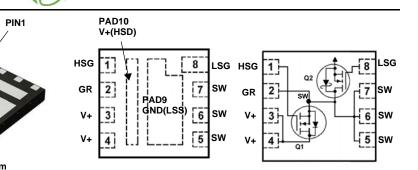
RoHS Compliant

### **General Description**

This device includes two specialized N-Channel MOSFETs in a dual package. The switch node has been internally connected to enable easy placement and routing of synchronous buck converters. The control MOSFET (Q1) and synchronous SyncFET<sup>TM</sup> (Q2) have been designed to provide optimal power efficiency.

#### Applications

- Computing
- Communications
- General Purpose Point of Load



Top Power Clip 5X6 Bottom

Pin	Name	Description	Pin	Name	Description	Pin	Name	Description
1	HSG	High Side Gate	3,4,10	V+(HSD)	High Side Drain	8	LSG	Low Side Gate
2	GR	Gate Return	5,6,7	SW	Switching Node, Low Side Drain	9	GND(LSS)	Low Side Source

MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter	Q1	Q2	Units		
V <sub>DS</sub>	Drain to Source Voltage			25	V	
V <sub>GS</sub>	Gate to Source Voltage		±12	±12	V	
	Drain Current -Continuous $T_C = 25 \text{ °C}$		60	110		
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25 °C	20 <sup>Note1a</sup>	41 <sup>Note1b</sup>	А	
	-Pulsed	T <sub>A</sub> = 25 °C (Note 4)	75	160	1	
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 3)	73	253	mJ	
P <sub>D</sub>	Power Dissipation for Single Operation T <sub>0</sub>		21	42	W	
	Power Dissipation for Single Operation	T <sub>A</sub> = 25 °C	2.1 <sup>Note1a</sup>	2.3 Note1b	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to	+150	°C		

#### Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	6.0	3.0	
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	60 <sup>Note1a</sup>	55 <sup>Note1b</sup>	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	130 <sup>Note1c</sup>	120 <sup>Note1d</sup>	

April 2014

FDPC8014S PowerTrench<sup>®</sup> Power Clip

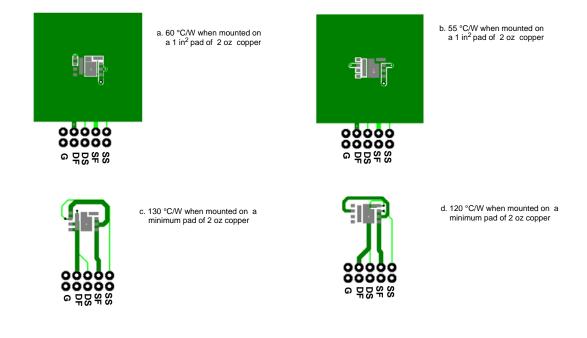
Device MarkingDevice05OD/16ODFDPC8014S		Package Power Clip 56	Reel Size		Tape Width 12 mm		Quantity 3000 units		
	al Chara	cteristics T <sub>J</sub> = 25 °C			_				1
Symbol		Parameter	Test Con	ditions	Туре	Min	Тур	Max	Units
Dff Chara	Drain to Source Breakdown Voltage		I <sub>D</sub> = 250 μA, V <sub>GS</sub> = I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0		Q1 Q2	25 25			V
ΔΒV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient		$I_D = 10$ mA, $v_{GS} = 0.0$ $I_D = 250 \mu$ A, referenced to 25 °C $I_D = 10$ mA, referenced to 25 °C		Q1 Q2	20	24 24		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current		$V_{DS} = 20 V, V_{GS} = 0 V$ $V_{DS} = 20 V, V_{GS} = 0 V$		Q1 Q2			1 500	μA μA
I <sub>GSS</sub>	Gate to So Forward	urce Leakage Current,	$V_{GS} = 12 \text{ V} / 8 \text{ V}, \text{ V}$ $V_{GS} = 12 \text{ V} / -8 \text{ V}, \text{ V}$	<sub>DS</sub> = 0 V	Q1 Q2			±100 ±100	nA nA
On Chara	cteristics								
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage				Q1 Q2	0.8 1.1	1.3 1.4	2.5 2.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{I}}$	Gate to Source Threshold Voltage Temperature Coefficient		$I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 10 \ \text{mA}$ , referenced to 25 °C				-4 -3		mV/°C
			$V_{GS} = 10V, I_D = 20$ $V_{GS} = 4.5 V, I_D = 1$ $V_{GS} = 10 V, I_D = 20$	A 8 A	Q1		2.8 3.4 3.9	3.8 4.7 5.3	
r <sub>DS(on)</sub>	Drain to So	ource On Resistance	$V_{GS} = 10V, I_D = 41 A$ $V_{GS} = 4.5 V, I_D = 37 A$ $V_{GS} = 10 V, I_D = 41 A, T_J = 125 °C$		Q2		0.9 1.0 1.1	1.2 1.4 1.5	mΩ
9 <sub>FS</sub>	Forward Tr	ansconductance	$V_{DS} = 5 V, I_D = 20$ $V_{DS} = 5 V, I_D = 47$	) A	Q1 Q2		182 315	1.0	S
Dynamic	Character	istics							
C <sub>iss</sub>	Input Capacitance Output Capacitance		Q1: $V_{DS} = 13 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHZ}$ -Q2: $V_{DS} = 13 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHZ}$		Q1 Q2		1695 6580	2375 9870	pF
C <sub>oss</sub>					Q1 Q2		495 1720	710 2580	pF
C <sub>rss</sub>	Reverse Transfer Capacitance				Q1 Q2		54 204	100 370	pF
R <sub>g</sub>	Gate Resistance				Q1 Q2	0.1 0.1	0.4 0.4	1.2 1.2	Ω
Switching	Characte	eristics							
t <sub>d(on)</sub>	Turn-On De	elay Time	Q1:		Q1 Q2		8 16	16 28	ns
t <sub>r</sub>	Rise Time		$Q_{DD} = 13 \text{ V}, \text{ I}_{D} = 20 \text{ A}, \text{ R}_{GEN} = 6 \Omega$ $Q_{2}:$ $V_{DD} = 13 \text{ V}, \text{ I}_{D} = 41 \text{ A}, \text{ R}_{GEN} = 6 \Omega$		Q1 Q2		2 6	10 11	ns
t <sub>d(off)</sub>	Turn-Off De	elay Time			Q1 Q2		24 47	38 75	ns
t <sub>f</sub>	Fall Time				Q1 Q2		2 4	10 10	ns
Q <sub>g</sub>	Total Gate	Charge	$V_{GS} = 0 V$ to 10 V	Q1	Q1 Q2		25 93	35 130	nC
Qg	Total Gate	Charge	$V_{GS} = 0 V \text{ to } 4.5 V$	$V_{DD} = 13 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	Q1 Q2		11 43	16 60	nC
Q <sub>gs</sub>	Gate to So	urce Gate Charge		Q2 V <sub>DD</sub> = 13 V, I <sub>D</sub>	Q1 Q2		3.4 13		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		= 41 A		Q1 Q2		2.2 8.5		nC

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Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Drain-Sou	urce Diode Characteristics						
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 20 A$ (Note 2) $V_{GS} = 0 V, I_S = 41 A$ (Note 2)	Q1 Q2		0.8 0.8	1.2 1.2	V
I <sub>S</sub>	Diode continuous forward current		Q1 Q2		60 110		A
I <sub>S,Pulse</sub>	Diode pulse current	-T <sub>C</sub> = 25 °C	Q1 Q2		75 160		А
t <sub>rr</sub>	Reverse Recovery Time $Q1$ $I_F = 20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		Q1 Q2		25 36	40 58	ns
Q <sub>rr</sub>	Reverse Recovery Charge	Q2 I <sub>F</sub> = 41 A, di/dt = 300 A/µs	Q1 Q2		10 47	20 75	nC

Notes

 $1.R_{\theta JA}$  is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.



2 Pulse Test: Pulse Width < 300  $\mu \text{s},$  Duty cycle < 2.0%.

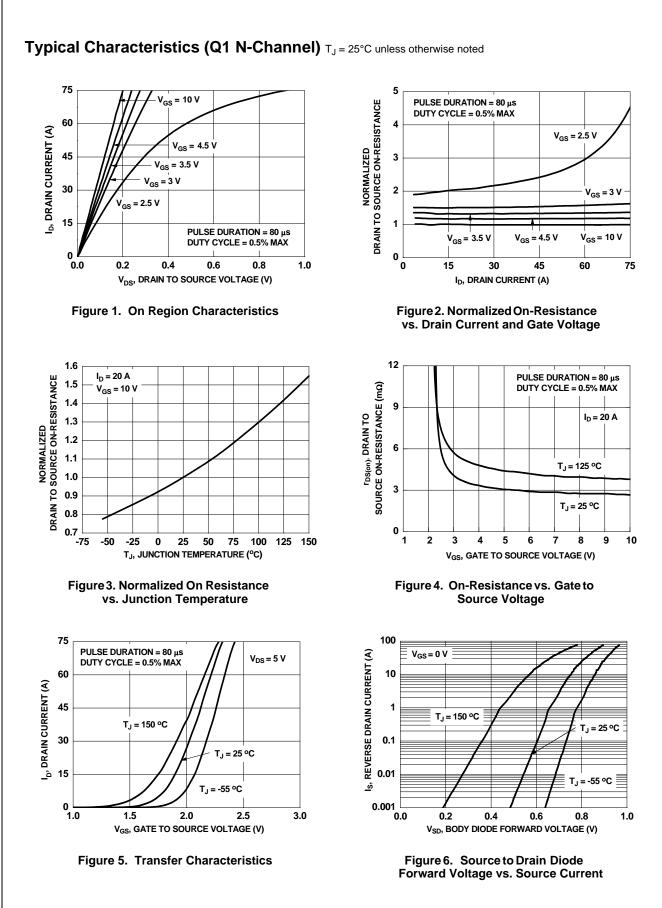
3. Q1 :  $E_{AS}$  of 73 mJ is based on starting  $T_J$  = 25 °C; N-ch: L = 3 mH,  $I_{AS}$  = 7 A,  $V_{DD}$  = 30 V,  $V_{GS}$  = 10 V. 100% test at L= 0.1 mH,  $I_{AS}$  = 24 A.

Q2: E<sub>AS</sub> of 253 mJ is based on starting T<sub>J</sub> = 25 °C; N-ch: L = 3 mH, I<sub>AS</sub> = 13 A, V<sub>DD</sub> = 25 V, V<sub>GS</sub> = 10 V. 100% test at L= 0.1 mH, I<sub>AS</sub> = 43 A.

4. Pulsed Id limited by junction temperature,td<=10 us. Please refer to SOA curve for more details.

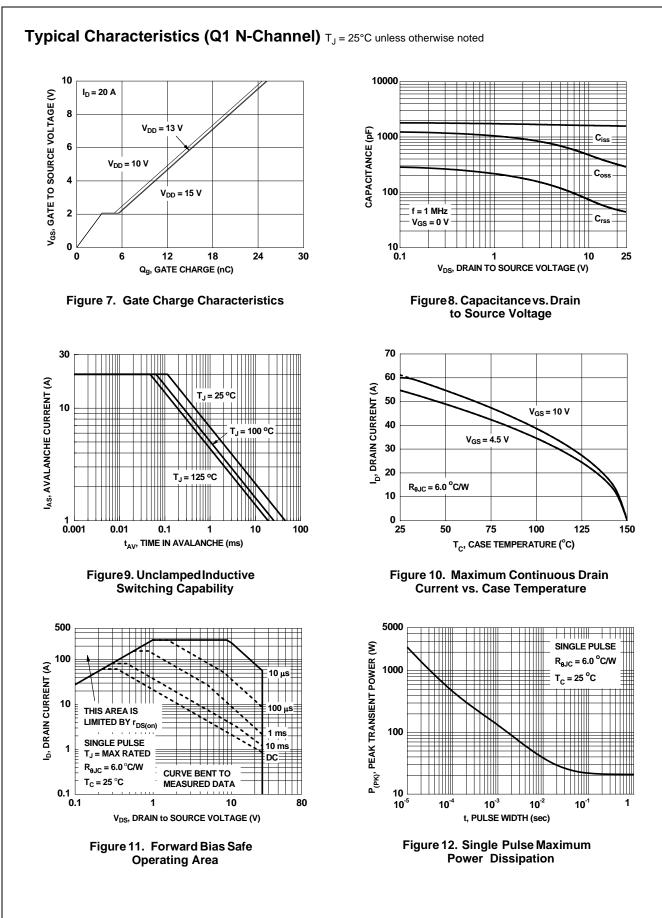
5. The continuous V<sub>DS</sub> rating is 25 V; However, a pulse of 30 V peak voltage for no longer than 100 ns duration at 600 KHz frequency can be applied.

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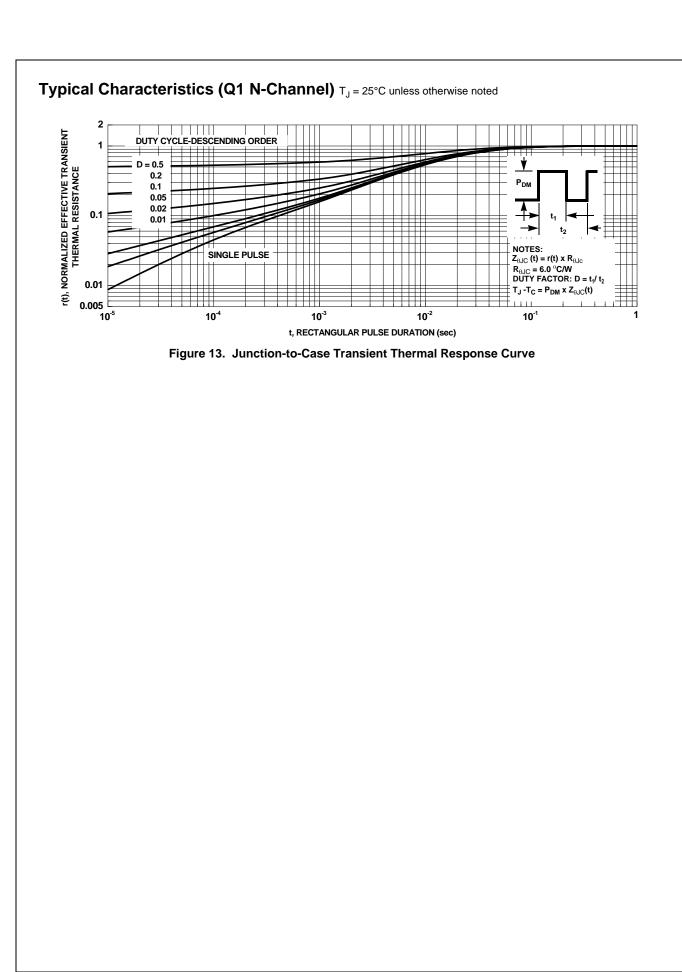


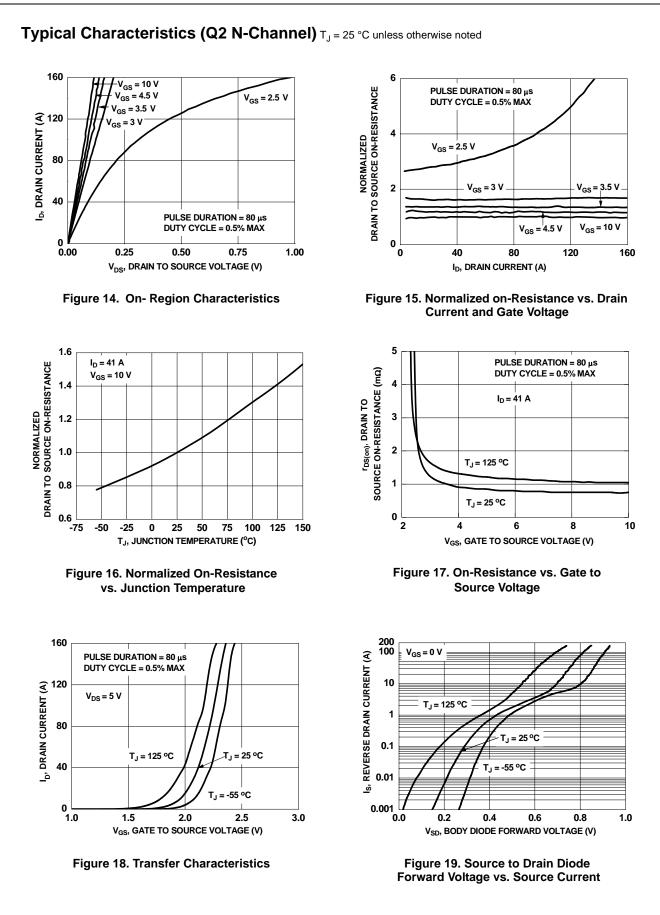
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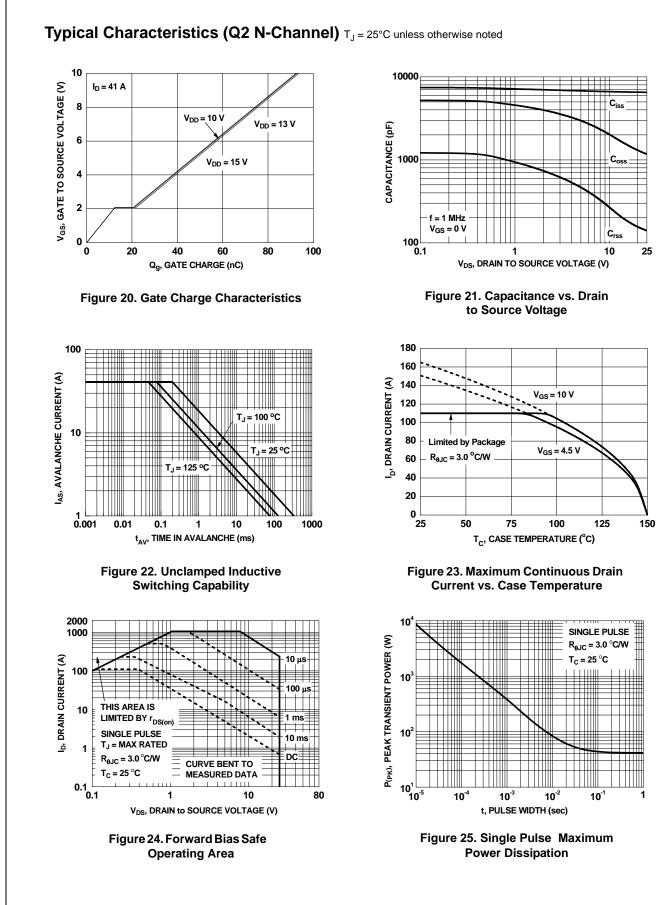




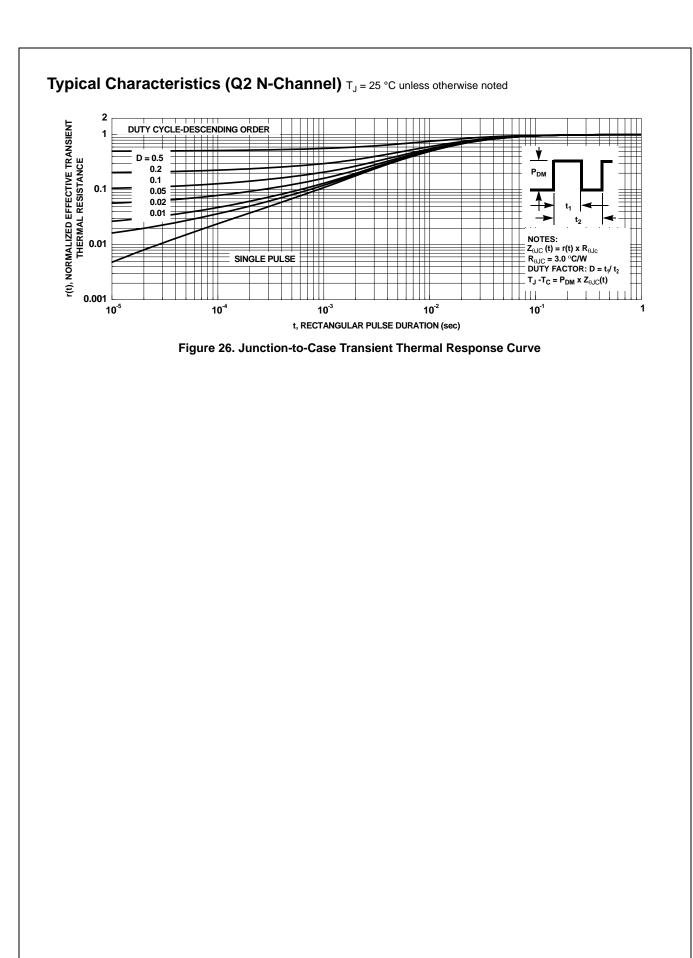








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## Typical Characteristics (continued)

## SyncFET<sup>™</sup> Schottky body diode Characteristics

Fairchild's SyncFET<sup>TM</sup> process embeds a Schottky diode in parallel with PowerTrench<sup>®</sup> MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 27 shows the reverses recovery characteristic of the FDPC8014S.

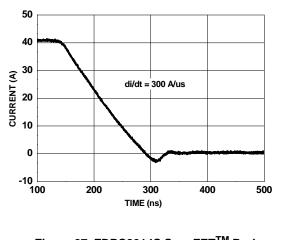


Figure 27. FDPC8014S SyncFET<sup>TM</sup> Body Diode Reverse Recovery Characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

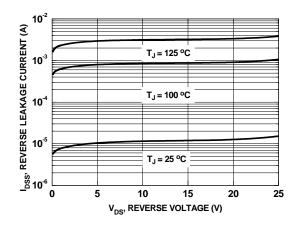
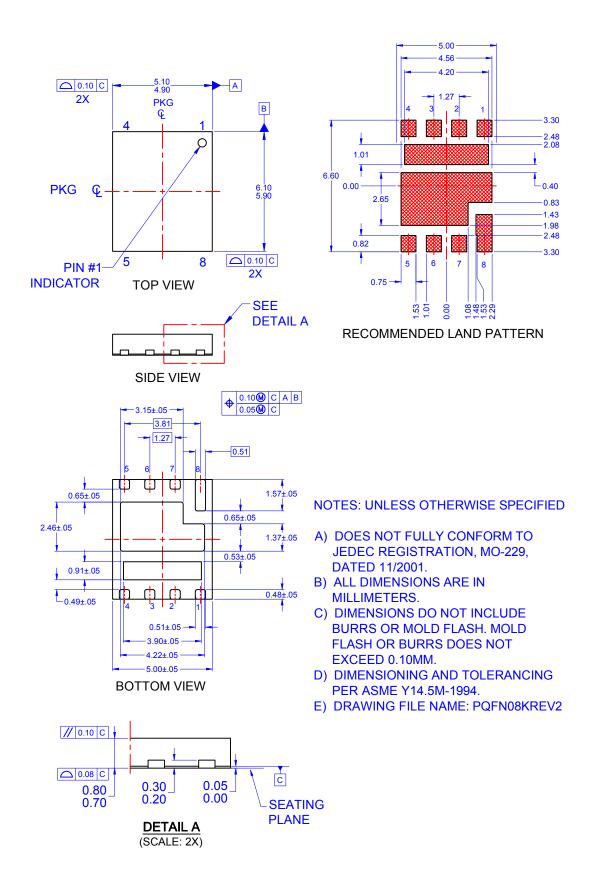


Figure 28. SyncFET<sup>™</sup> Body Diode Reverse Leakage vs. Drain-source Voltage



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